











LM340, LM340A, LM7805, LM7812, LM7815

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LM340, LM340A and LM7805 Family Wide V_{IN} 1.5-A Fixed Voltage Regulators

Features

- Output Current up to 1.5 A
- Available in Fixed 5-V, 12-V, and 15-V Options
- Output Voltage Tolerances of $\pm 2\%$ at $T_{\perp} = 25$ °C (LM340A)
- Line Regulation of 0.01% / V of at 1-A Load (LM340A)
- Load Regulation of 0.3% / A (LM340A)
- Internal Thermal Overload, Short-Circuit and SOA Protection
- Available in Space-Saving SOT-223 Package
- Output Capacitance Not Required for Stability

Applications

- **Industrial Power Supplies**
- **SMPS Post Regulation**
- **HVAC Systems**
- **AC Inventors**
- Test and Measurement Equipment
- Brushed and Brushless DC Motor Drivers
- Solar Energy String Invertors

Available Packages



3 Description

The LM340 and LM7805 Family monolithic 3-terminal positive voltage regulators employ internal currentlimiting, thermal shutdown and safe-area compensation, making them essentially indestructible. If adequate heat sinking is provided, they can deliver over 1.5-A output current. They are intended as fixed voltage regulators in a wide range of applications including local (on-card) regulation for elimination of noise and distribution problems associated with single-point regulation. In addition to use as fixed voltage regulators, these devices can be used with external components to obtain adjustable output voltages and currents.

Considerable effort was expended to make the entire series of regulators easy to use and minimize the number of external components. It is not necessary to bypass the output, although this does improve transient response. Input bypassing is needed only if the regulator is located far from the filter capacitor of the power supply.

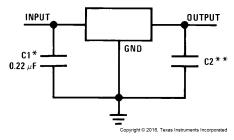
LM7805 is also available in a higher accuracy and better performance version (LM340A). Refer to LM340A specifications in the LM340A Electrical Characterisitcs table.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)		
LM340x LM7805 Family	DDPAK/TO-263 (3)	10.18 mm × 8.41 mm		
	SOT-223 (4)	6.50 mm × 3.50 mm		
	TO-220 (3)	14.986 mm × 10.16 mm		
	TO-3 (2)	38.94 mm x 25.40 mm		

For all available packages, see the orderable addendum at the end of the data sheet.

Fixed Output Voltage Regulator



*Required if the regulator is located far from the power supply filter.

**Although no output capacitor is needed for stability, it does help transient response. (If needed, use 0.1-μF, ceramic disc).



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4 Revision History

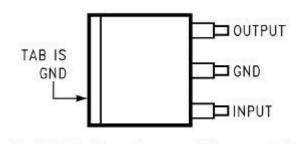
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

C	nanges from Revision K (November 2015) to Revision L
•	Changed pinout number order for the TO-220 and SOT-223 packages from: 2, 3, 1 to: 1, 2, 3
C	nanges from Revision J (December 2013) to Revision K
•	Added ESD Ratings table, Thermal Information table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section
•	Deleted obsolete LM140 and LM7808C devices from the data sheet
•	Changed Figure 13 caption from Line Regulation 140AK-5.0 to Line Regulation LM340,
•	Changed Figure 14 caption from Line Regulation 140AK-5.0 to Line Regulation LM340,
C	nanges from Revision I (March 2013) to Revision J
	Changed 0.5 from typ to max

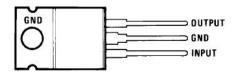


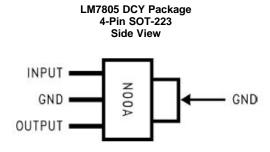
5 Pin Configuration and Functions

LM7805 and LM7812 KTT Package 3-Pin DDPAK/TO-263 Top View

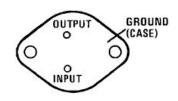


LM7805, LM7812, and LM7815 NDE Package 3-Pin TO-220 Top View





LM340K-5.0 NDS Package 2-Pin TO-3 Top View



Pin Functions

P	PIN		DESCRIPTION
NAME NO.		I/O	DESCRIPTION
INPUT	1	I	Input voltage pin
GND	2	I/O	Ground pin
OUTPUT	3	0	Output voltage pin



6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)(2)

		MIN	MAX	UNIT
DC input voltage			35	V
Internal power dissipation (3)	ernal power dissipation (3)		Limited	
Maximum junction temperature			150	°C
Land (and and and the facilities of AC and)	TO-3 package (NDS)		300	°C
Lead temperature (soldering, 10 sec.)	Lead temperature 1,6 mm (1/16 in) from case for 10 s		230	°C
Storage temperature		-65	150	°C

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (3) The maximum allowable power dissipation at any ambient temperature is a function of the maximum junction temperature for operation (T_{JMAX} = 125°C or 150°C), the junction-to-ambient thermal resistance (θ_{JA}), and the ambient temperature (T_A). P_{DMAX} = (T_{JMAX} ¬ T_A)/θ_{JA}. If this dissipation is exceeded, the die temperature rises above T_{JMAX} and the electrical specifications do not apply. If the die temperature rises above 150°C, the device goes into thermal shutdown. For the TO-3 package (NDS), the junction-to-ambient thermal resistance (θ_{JA}) is 39°C/W. When using a heat sink, θ_{JA} is the sum of the 4°C/W junction-to-case thermal resistance (θ_{JC}) of the TO-3 package and the case-to-ambient thermal resistance of the heat sink. For the TO-220 package (NDE), θ_{JA} is 54°C/W and θ_{JC} is 4°C/W. If SOT-223 is used, the junction-to-ambient thermal resistance is 174°C/W and can be reduced by a heat sink (see Applications Hints on heat sinking). If the DDPAK\TO-263 package is used, the thermal resistance can be reduced by increasing the PCB copper area thermally connected to the package: Using 0.5 square inches of copper area, θ_{JA} is 50°C/W; with 1 square inch of copper area, θ_{JA} is 37°C/W; and with 1.6 or more inches of copper area, θ_{JA} is 32°C/W.

6.2 ESD Ratings

		VALUE	UNIT
V _(ESD) Electrostatic discharge	Human-body model (HBM) ⁽¹⁾	±2000	V

⁽¹⁾ ESD rating is based on the human-body model, 100 pF discharged through 1.5 k Ω .

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
Temperature (T _A)	LM340A, LM340	0	125	°C

6.4 Thermal Information

			LM340, LM780	5 Family		
	$\begin{array}{ll} R_{\theta JC(top)} & \text{Junction-to-case (top) thermal resistance} \\ R_{\theta JB} & \text{Junction-to-board thermal resistance} \\ \psi_{JT} & \text{Junction-to-top characterization parameter} \\ \psi_{JB} & \text{Junction-to-board characterization parameter} \end{array}$	NDE KTT (TO-220) (DDPAK/TO-263)		DCY (SOT-223)	NDS (TO-3)	UNIT
		3 PINS	3 PINS	4 PINS	2 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	23.9	44.8	62.1	39	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	16.7	45.6	44	2	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	5.3	24.4	10.7	_	°C/W
ΨЈΤ	Junction-to-top characterization parameter	3.2	11.2	2.7	_	°C/W
ΨЈВ	Junction-to-board characterization parameter	5.3	23.4	10.6	_	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	1.7	1.5	_	_	°C/W

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.



6.5 LM340A Electrical Characteristics, $V_0 = 5 \text{ V}$, $V_1 = 10 \text{ V}$

 $I_{OUT} = 1 \text{ A}, 0^{\circ}\text{C} \le T_{\perp} \le 125^{\circ}\text{C} \text{ (LM340A) unless otherwise specified}^{(1)}$

	PARAMETER	TI	EST CONDITIONS	MIN	TYP	MAX	UNIT
		T _J = 25°C		4.9	5	5.1	V
Vo	Output voltage	P _D ≤ 15 W, 5 mA	≤ I _O ≤ 1 A	4.8		5.2	.,
		$7.5 \text{ V} \le \text{V}_{IN} \le 20$	O V				V
		7.5 V ≤ V _{IN} ≤ 20	T _J = 25°C		3	10	mV
		V	Over temperature, I _O = 500 mA			10	mV
Line re Load r Quieso Ala Quieso change	Line regulation	01/41/4401/	T _J = 25°C			4	mV
		8 V ≤ V _{IN} ≤ 12 V	Over temperature			12	mV
		T 0500	5 mA ≤ I _O ≤ 1.5 A		10	25	mV
ΔV_{O}	V _O Load regulation	T _J = 25°C	250 mA ≤ I _O ≤ 750 mA			15	mV
		Over temperature, 5 mA ≤ I _O ≤ 1 A				25	mV
	0	T _J = 25°C				6	mA
IQ	Quiescent current	Over temperature				6.5	mA
		T _J = 25°C, I _O = 1 A				0.8	A
		7.5 V ≤ V _{IN} ≤ 20 V					mA
ΔI_Q	Quiescent current change	Over temperature	, 5 mA ≤ I _O ≤ 1 A			0.5	mA
	onango	Over temperature, I _O = 500 mA				0.8	mA
		8 V ≤ V _{IN} ≤ 25 \	/				mA
V _N	Output noise voltage	T _A = 25°C, 10 Hz	≤ f ≤ 100 kHz		40		μV
ΔV _{IN}		f = 120 Hz	T _J = 25°C, , I _O = 1 A	68	80		dB
ΔV _{OUT}	Ripple rejection	$\begin{array}{c} 8 \ V \le V_{\text{IN}} \le 18 \\ V \end{array}$	Over temperature, I _O = 500 mA	68			dB
	Dropout voltage	$T_J = 25^{\circ}C, I_O = 1$	A		2		V
	Output resistance	f = 1 kHz			8		mΩ
ΔV _{IN}	Short-circuit current	T _J = 25°C			2.1		А
	Peak output current	T _J = 25°C			2.4		Α
	Average TC of V _O	Min, T _J = 0°C, I _O =	= 5 mA		-0.6		mV/°C
V _{IN}	Input voltage required to maintain line regulation	T _J = 25°C		7.5			V

⁽¹⁾ All characteristics are measured with a 0.22-μF capacitor from input to ground and a 0.1-μF capacitor from output to ground. All characteristics except noise voltage and ripple rejection ratio are measured using pulse techniques (t_w ≤ 10 ms, duty cycle ≤ 5%). Output voltage changes due to changes in internal temperature must be taken into account separately.

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6.6 LM340 / LM7805 Electrical Characteristics, $V_0 = 5 \text{ V}$, $V_1 = 10 \text{ V}$

 $0^{\circ}\text{C} \le \text{T}_{\text{J}} \le 125^{\circ}\text{C}$ unless otherwise specified⁽¹⁾

	PARAMETER	TES	T CONDITIONS	MIN	TYP	MAX	UNIT
		T _J = 25°C, 5 mA ≤ l	_O ≤ 1 A	4.8	5	5.2	V
Vo	Output voltage	P _D ≤ 15 W, 5 mA ≤	I _O ≤ 1 A	4.75		5.25	.,
		$7.5 \text{ V} \le \text{V}_{IN} \le 20$	V				V
			T _J = 25°C		3	50	
		. 500 4	7V ≤ V _{IN} ≤ 25V				mV
		I _O = 500 mA	Over temperature			50	.,
	12 1.2		8V ≤ V _{IN} ≤ 20V				mV
ΔV_{O}	Line regulation		T _J = 25°C			50	.,
			7.5V ≤ V _{IN} ≤ 20V				mV
		I _O ≤ 1 A	Over temperature			25	
			8V ≤ V _{IN} ≤ 12V				mV
		T 0500	5 mA ≤ I _O ≤ 1.5 A		10	50	mV
ΔV_{O}	Load regulation	T _J = 25°C	250 mA ≤ I _O ≤ 750 mA			25	mV
		Over temperature, 5 mA ≤ I _O ≤ 1 A				50	mV
		1 - 4 4	T _J = 25°C			8	mA
IQ	Quiescent current	I _O ≤ 1 A	Over temperature			8.5	mA
		$0^{\circ}\text{C} \le \text{T}_{\text{J}} \le 125^{\circ}\text{C}, 5 \text{ mA} \le \text{I}_{\text{O}} \le 1 \text{ A}$			0.5		mA
ΔI_{O}	Quiescent current change	7 V ≤ V _{IN} ≤ 20 V	$T_J = 25^{\circ}C, I_O \le 1 A$			1	mA
ΔIQ	Quiescent current change		Over temperature, I _O ≤ 500 mA			1	mA
V _N	Output noise voltage	T _A = 25°C, 10 Hz ≤	f ≤ 100 kHz		40		μV
ΔV _{IN}		f = 120 Hz	T _J = 25°C, I _O ≤ 1 A	62	80		dB
ΔV _{OUT}	Ripple rejection	$8 \text{ V} \le \text{V}_{\text{IN}} \le 18 \text{ V}$	Over temperature, I _O ≤ 500 mA	62			dB
	Dropout voltage	$T_J = 25^{\circ}C, I_O = 1 A$			2		V
	Output resistance	f = 1 kHz			8		mΩ
R _O	Short-circuit current	T _J = 25°C			2.1		Α
	Peak output current	T _J = 25°C			2.4		Α
	Average TC of V _{OUT}	Over temperature, I	_O = 5 mA		-0.6		mV/°C
V _{IN}	Input voltage required to maintain line regulation	$T_{J} = 25^{\circ}C, I_{O} \le 1 \text{ A}$		7.5			V

⁽¹⁾ All characteristics are measured with a 0.22-μF capacitor from input to ground and a 0.1-μF capacitor from output to ground. All characteristics except noise voltage and ripple rejection ratio are measured using pulse techniques (t_w ≤ 10 ms, duty cycle ≤ 5%). Output voltage changes due to changes in internal temperature must be taken into account separately.



6.7 LM340 / LM7812 Electrical Characteristics, $V_O = 12 \ V, \ V_I = 19 \ V$

 $0^{\circ}\text{C} \le \text{T}_{\text{J}} \le 125^{\circ}\text{C}$ unless otherwise specified⁽¹⁾

	PARAMETER	TES"	T CONDITIONS	MIN	TYP	MAX	UNIT
		$T_J = 25^{\circ}C$, 5 mA $\leq I_O \leq 1$ A		11.5	12	12.5	V
′ o	Output voltage	P _D ≤ 15 W, 5 mA ≤ l	₀ ≤ 1 A	11.4		12.6	V
Vo Vo II		14.5 V ≤ V _{IN} ≤ 27	V				V
			T _J = 25°C		4	120	
			$14.5 \text{V} \leq \text{V}_{\text{IN}} \leq 30 \text{V}$				mV
		I _O = 500 mA	Over temperature			120	
ΔV_{O}	12		15V ≤ V _{IN} ≤ 27V				mV
	Line regulation		T _J = 25°C			120	
			$14.6V \le V_{IN} \le 27V$				mV
		I _O ≤ 1 A	Over temperature			60	
			16V ≤ V _{IN} ≤ 22V				mV
		T 0500	5 mA ≤ I _O ≤ 1.5 A		12	120	mV
ΔV _O	Load regulation	T _J = 25°C	250 mA ≤ I _O ≤ 750 mA			60	mV
		Over temperature, 5	Over temperature, 5 mA ≤ I _O ≤ 1 A			120	mV
IQ	Quiescent current	I _O ≤ 1 A	T _J = 25°C			8	mA
			Over temperature			8.5	mA
		5 mA ≤ I _O ≤ 1 A			0.5		mA
		$T_J = 25^{\circ}C, I_O \le 1 A$				1	m ^
Δl _Q	Quiescent current change	14.8 V ≤ V _{IN} ≤ 27	V				mA
		Over temperature, I _O ≤ 500 mA				1	
		14.5 V ≤ V _{IN} ≤ 30 V					mA
/ _N	Output noise voltage	T _A = 25°C, 10 Hz ≤	f ≤ 100 kHz		75		μV
ΔV_{IN}		f = 120 Hz	$T_J = 25^{\circ}C, I_O \le 1 A$	55	72		dB
∆V _{OUT}	Ripple rejection	15 V ≤ V _{IN} ≤ 25 V	Over temperature, I _O ≤ 500 mA,	55			dB
	Dropout voltage	$T_J = 25^{\circ}C, I_O = 1 A$			2		V
	Output resistance	f = 1 kHz			18		mΩ
R _O	Short-circuit current	T _J = 25°C			1.5		Α
	Peak output current	T _J = 25°C			2.4		Α
	Average TC of V _{OUT}	Over temperature, I ₀	Over temperature, I _O = 5 mA		- 1.5		mV/°C
/ _{IN}	Input voltage required to maintain line regulation	$T_{J} = 25^{\circ}C, I_{O} \le 1 \text{ A}$		14.6			V

⁽¹⁾ All characteristics are measured with a 0.22-μF capacitor from input to ground and a 0.1-μF capacitor from output to ground. All characteristics except noise voltage and ripple rejection ratio are measured using pulse techniques (t_w ≤ 10 ms, duty cycle ≤ 5%). Output voltage changes due to changes in internal temperature must be taken into account separately.



6.8 LM340 / LM7815 Electrical Characteristics, $V_0 = 15 \text{ V}$, $V_1 = 23 \text{ V}$

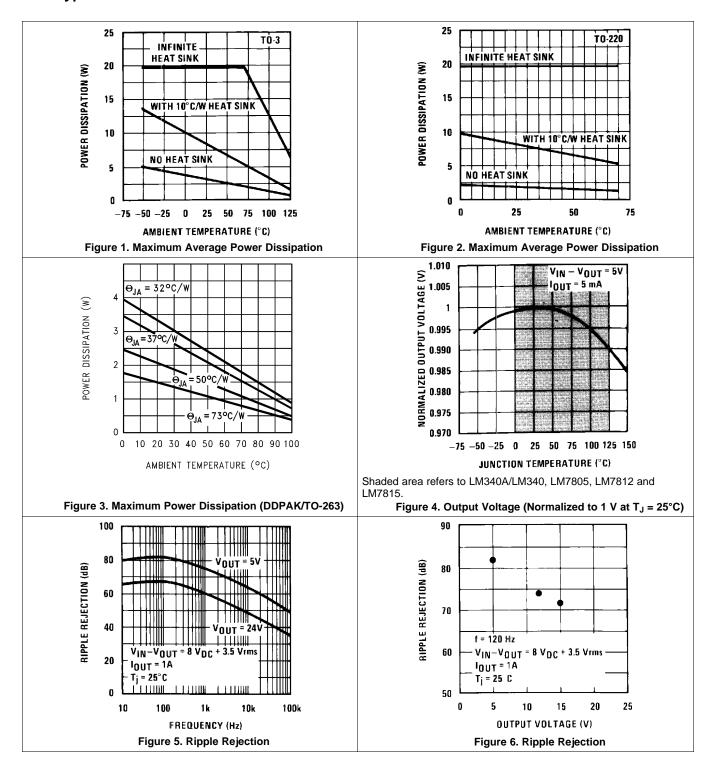
 $0^{\circ}\text{C} \le \text{T}_{\text{J}} \le 125^{\circ}\text{C}$ unless otherwise specified⁽¹⁾

	PARAMETER	TES	T CONDITIONS	MIN	TYP	MAX	UNIT
		$T_{J} = 25^{\circ}C, 5 \text{ mA} \le I_{0}$	o ≤ 1 A	14.4	15	15.6	V
Vo	Output voltage	P _D ≤ 15 W, 5 mA ≤ l	I _O ≤ 1 A	14.25		15.75	V
		17.5 V ≤ V _{IN} ≤ 30	V				V
			T _J = 25°C		4	150	\/
			17.5 V ≤ V _{IN} ≤ 30 V				mV
		I _O = 500 mA	Over temperature			150	
	V _O Line regulation		18.5 V ≤ V _{IN} ≤ 30 V				mV
ΔV_{O}			T _J = 25°C			150	.,,
			17.7 V ≤ V _{IN} ≤ 30 V				mV
		I _O ≤ 1 A	Over temperature			75	
			20 V ≤ V _{IN} ≤ 26 V				mV
		T 0500	5 mA ≤ I _O ≤ 1.5 A		12	150	mV
ΔV_{O}	Load regulation	T _J = 25°C	250 mA ≤ I _O ≤ 750 mA			75	mV
		Over temperature, 5	mA ≤ I _O ≤ 1 A,			150	mV
	Quiescent current		T _J = 25°C			8	mA
IQ		I _O ≤ 1 A	Over temperature			8.5	mA
		5 mA ≤ I _O ≤ 1 A			0.5		mA
		$T_J = 25^{\circ}C, I_O \le 1 A$				1	
ΔI_Q	Quiescent current change	17.9 V ≤ V _{IN} ≤ 30	V				mA
		Over temperature, I ₀	_O ≤ 500 mA			1	
		17.5 V ≤ V _{IN} ≤ 30	V				mA
V _N	Output noise voltage	T _A = 25°C, 10 Hz ≤	f ≤ 100 kHz		90		μV
ΔV_{IN}		f = 120 Hz	$T_J = 25^{\circ}C, I_O \le 1 \text{ A}$	54	70		dB
ΔV _{OUT}	Ripple rejection	18.5 V ≤ V _{IN} ≤ 28.5 V	Over temperature, I _O ≤ 500 mA,	54			dB
	Dropout voltage	T _J = 25°C, I _O = 1 A			2		V
	Output resistance	f = 1 kHz			19		mΩ
R _O	Short-circuit current	T _J = 25°C			1.2		Α
	Peak output current	T _J = 25°C			2.4		Α
	Average TC of V _{OUT}	Over temperature, I ₀	_O = 5 mA		-1.8		mV/°C
V _{IN}	Input voltage required to maintain line regulation	$T_{J} = 25^{\circ}C, I_{O} \le 1 \text{ A}$		17.7			V

⁽¹⁾ All characteristics are measured with a 0.22-μF capacitor from input to ground and a 0.1-μF capacitor from output to ground. All characteristics except noise voltage and ripple rejection ratio are measured using pulse techniques (t_w ≤ 10 ms, duty cycle ≤ 5%). Output voltage changes due to changes in internal temperature must be taken into account separately.

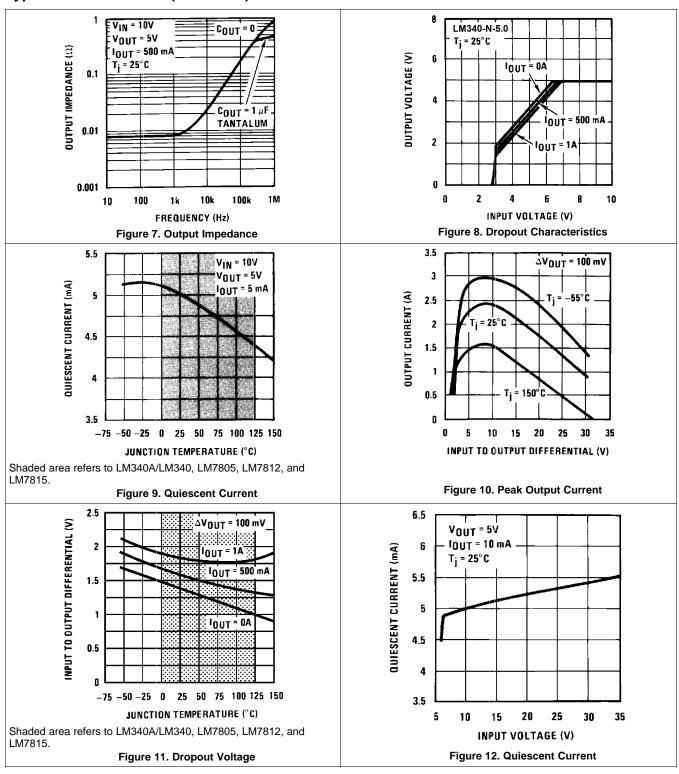


6.9 Typical Characteristics



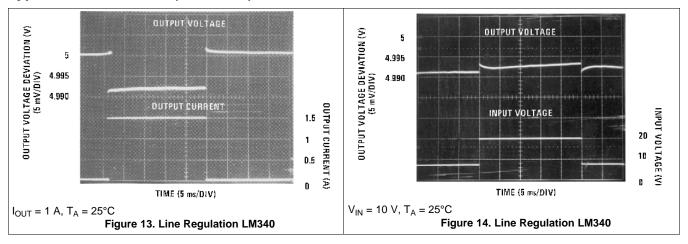


Typical Characteristics (continued)





Typical Characteristics (continued)



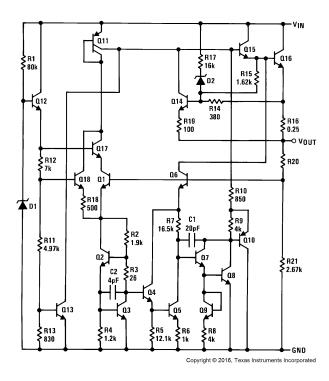


7 Detailed Description

7.1 Overview

The LM340 and LM7805 devices are a family of fixed output positive voltage regulators with outputs ranging from 3 V to 15 V. They accept up to 35 V of input voltage and with proper heat dissipation can provide over 1.5 A of current. With a combination of current limiting, thermal shutdown, and safe area protection, these regulators eliminate any concern of damage. These features paired with excellent line and load regulation make the LM340 and LM7805 Family versatile solutions to a wide range of power management designs. Although the LM340 and LM7805 Family were designed primarily as fixed-voltage regulators, these devices can be used with external component for adjustable voltage and current.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Output Current

With proper considerations, the LM340 and LM7805 Family can exceed 1.5-A output current. Depending on the desired package option, the effective junction-to-ambient thermal resistance can be reduced through heat sinking, allowing more power to be dissipated in the device.

7.3.2 Current Limiting Feature

In the event of a short circuit at the output of the regulator, each device has an internal current limit to protect it from damage. The typical current limits for the LM340 and LM7805 Family is 2.4 A.

7.3.3 Thermal Shutdown

Each package type employs internal current limiting and thermal shutdown to provide safe operation area protection. If the junction temperature is allowed to rise to 150°C, the device will go into thermal shutdown.

7.4 Device Functional Modes

There are no functional modes for this device.



8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The LM340x and LM7805 series is designed with thermal protection, output short-circuit protection, and output transistor safe area protection. However, as with any IC regulator, it becomes necessary to take precautions to assure that the regulator is not inadvertently damaged. The following describes possible misapplications and methods to prevent damage to the regulator.

8.1.1 Shorting the Regulator Input

When using large capacitors at the output of these regulators, a protection diode connected input to output (Figure 15) may be required if the input is shorted to ground. Without the protection diode, an input short causes the input to rapidly approach ground potential, while the output remains near the initial V_{OUT} because of the stored charge in the large output capacitor. The capacitor will then discharge through a large internal input to output diode and parasitic transistors. If the energy released by the capacitor is large enough, this diode, low current metal, and the regulator are destroyed. The fast diode in Figure 15 shunts most of the capacitors discharge current around the regulator. Generally no protection diode is required for values of output capacitance $\leq 10 \ \mu\text{F}$.

8.1.2 Raising the Output Voltage Above the Input Voltage

Because the output of the device does not sink current, forcing the output high can cause damage to internal low current paths in a manner similar to that just described in *Shorting the Regulator Input*.

8.1.3 Regulator Floating Ground

When the ground pin alone becomes disconnected, the output approaches the unregulated input, causing possible damage to other circuits connected to V_{OUT}. If ground is reconnected with power ON, damage may also occur to the regulator. This fault is most likely to occur when plugging in regulators or modules with on card regulators into powered up sockets. The power must be turned off first, the thermal limit ceases operating, or the ground must be connected first if power must be left on. See Figure 16.

8.1.4 Transient Voltages

If transients exceed the maximum rated input voltage of the device, or reach more than 0.8 V below ground and have sufficient energy, they will damage the regulator. The solution is to use a large input capacitor, a series input breakdown diode, a choke, a transient suppressor or a combination of these.

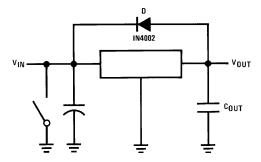


Figure 15. Input Short

Application Information (continued)

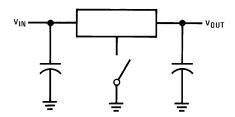


Figure 16. Regulator Floating Ground

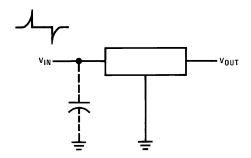


Figure 17. Transients

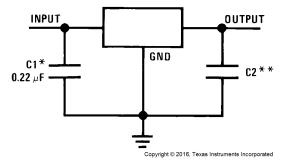
When a value for $\theta_{(H-A)}$ is found, a heat sink must be selected that has a value that is less than or equal to this number.

 $\theta_{(H-A)}$ is specified numerically by the heat sink manufacturer in this catalog or shown in a curve that plots temperature rise vs power dissipation for the heat sink.

8.2 Typical Applications

8.2.1 Fixed Output Voltage Regulator

The LM340x and LM7805 Family devices are primarily designed to provide fixed output voltage regulation. The simplest implementation of LM340x and LM7805 Family is shown in Figure 18.



*Required if the regulator is located far from the power supply filter.

Figure 18. Fixed Output Voltage Regulator

8.2.1.1 Design Requirements

The device component count is very minimal. Although not required, TI recommends employing bypass capacitors at the output for optimum stability and transient response. These capacitors must be placed as close as possible to the regulator. If the device is located more than 6 inches from the power supply filter, it is required to employ input capacitor.

^{**}Although no output capacitor is needed for stability, it does help transient response. (If needed, use 0.1- μF , ceramic disc).



Typical Applications (continued)

8.2.1.2 Detailed Design Procedure

The output voltage is set based on the device variant. LM340x and LM7805 Family are available in 5-V, 12-V and 15-V regulator options.

8.2.1.3 Application Curve

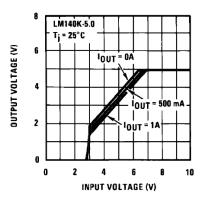
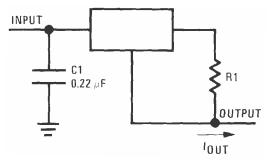


Figure 19. V_{OUT} vs V_{IN} , $V_{OUT} = 5 \text{ V}$

8.3 System Examples



 I_{OUT} = V2–3 / R1 + I_{Q} ΔI_{Q} = 1.3 mA over line and load changes.

Figure 20. Current Regulator

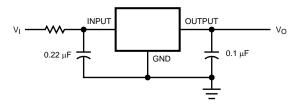
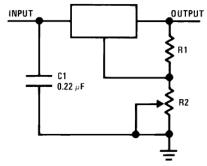


Figure 22. High Input Voltage Circuit With Series Resistor



 $V_{OUT} = 5 \text{ V} + (5 \text{ V/R1} + I_Q) \text{ R2 5 V/R1} > 3 \text{ I}_Q,$ load regulation (L_r) \approx [(R1 + R2)/R1] (L_r of LM340-5).

Figure 21. Adjustable Output Regulator

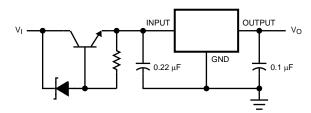
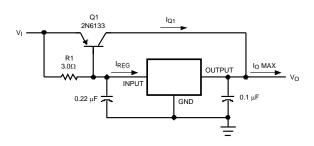
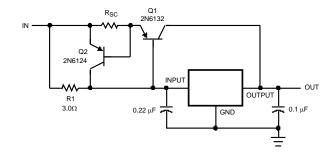


Figure 23. High Input Voltage Circuit implementation With Transistor



System Examples (continued)





$$\begin{split} \beta(\text{Q1}) &\geq I_{\text{O Max}} \, / \, I_{\text{REG Max}} \\ \text{R1} &= 0.9 \, / \, I_{\text{REG}} = \beta_{\text{(Q1)}} \, V_{\text{BE(Q1)}} \, / \, I_{\text{REG Max } (\beta \, +1)} - I_{\text{O Max}} \end{split}$$

 $R_{SC} = 0.8 / I_{SC}$ R1 = $\beta V_{BE(Q1)} / I_{REG Max} (\beta +1) - I_{O Max}$

Figure 24. High Current Voltage Regulator

Figure 25. High Output Current With Short-Circuit Protection

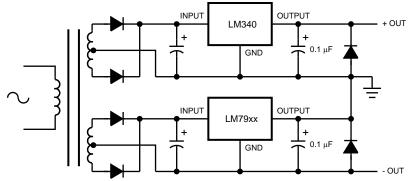


Figure 26. LM340 Used With Negative Regulator LM79xx



9 Power Supply Recommendations

The LM340 is designed to operate from a wide input voltage up to 35 V. Please refer to electrical characteristics tables for the minimum input voltage required for line/load regulation. If the device is more than six inches from the input filter capacitors, an input bypass capacitor, $0.1~\mu F$ or greater, of any type is needed for stability.

10 Layout

10.1 Layout Guidelines

Some layout guidelines must be followed to ensure proper regulation of the output voltage with minimum noise. Traces carrying the load current must be wide to reduce the amount of parasitic trace inductance. To improve PSRR, a bypass capacitor can be placed at the OUTPUT pin and must be placed as close as possible to the IC. All that is required for the typical fixed output regulator application circuit is the LM340x/LM7805 Family IC and a 0.22-µF input capacitor if the regulator is placed far from the power supply filter. A 0.1-µF output capacitor is recommended to help with transient response. In cases when VIN shorts to ground, an external diode must be placed from VOUT to VIN to divert the surge current from the output capacitor and protect the IC.

10.2 Layout Example

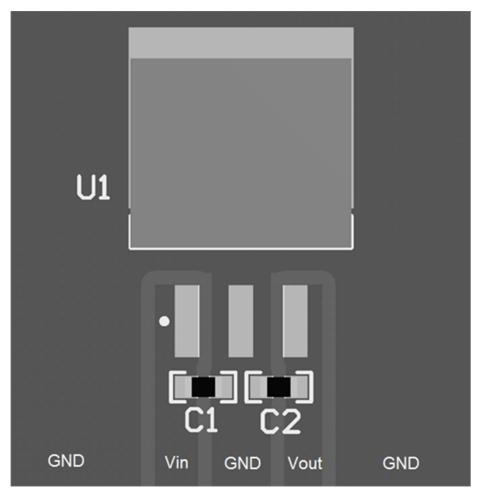


Figure 27. Layout Example DDPAK



Layout Example (continued)

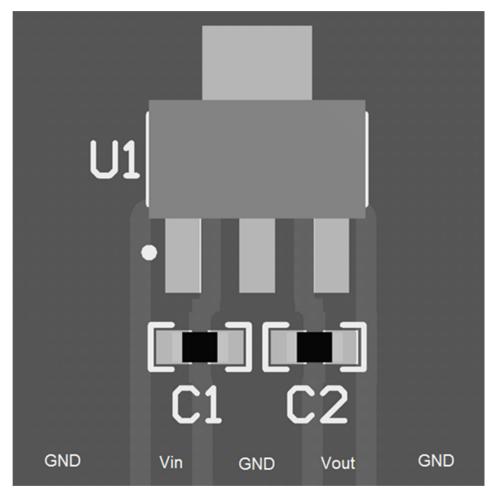


Figure 28. Layout Example SOT-223

10.3 Heat Sinking DDPAK/TO-263 and SOT-223 Package Parts

Both the DDPAK/TO-263 (KTT) and SOT-223 (DCY) packages use a copper plane on the PCB and the PCB itself as a heat sink. To optimize the heat sinking ability of the plane and PCB, solder the tab of the plane.

Figure 29 shows for the DDPAK/TO-263 the measured values of $\theta_{(J-A)}$ for different copper area sizes using a typical PCB with 1-oz copper and no solder mask over the copper area used for heat sinking.

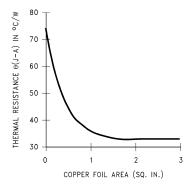


Figure 29. $\theta_{(J-A)}$ vs Copper (1 Ounce) Area for the DDPAK/TO-263 Package



Heat Sinking DDPAK/TO-263 and SOT-223 Package Parts (continued)

As shown in Figure 29, increasing the copper area beyond 1 square inch produces very little improvement. It should also be observed that the minimum value of $\theta_{(J-A)}$ for the DDPAK/TO-263 package mounted to a PCB is 32°C/W.

As a design aid, Figure 30 shows the maximum allowable power dissipation compared to ambient temperature for the DDPAK/TO-263 device (assuming $\theta_{(J-A)}$ is 35°C/W and the maximum junction temperature is 125°C).

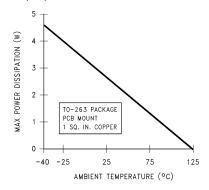
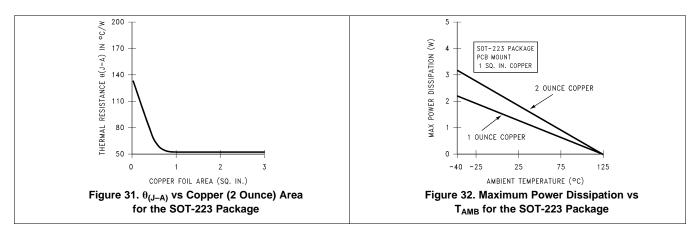


Figure 30. Maximum Power Dissipation vs T_{AMB} for the DDPAK/TO-263 Package

Figure 31 and Figure 32 show the information for the SOT-223 package. Figure 31 assumes a $\theta_{(J-A)}$ of 74°C/W for 1-oz. copper and 51°C/W for 2-oz. copper and a maximum junction temperature of 125°C.



See AN-1028 LMX2370 PLLatinum Dual Freq Synth for RF Pers Comm LMX2370 2.5GHz/1.2GHz (SNVA036) for power enhancement techniques to be used with the SOT-223 package.



11 Device and Documentation Support

11.1 Documentation Support

11.1.1 Related Documentation

For related documentation, see the following:

- AN-1028 LMX2370 PLLatinum Dual Freg Synth for RF Pers Comm LMX2370 2.5GHz/1.2GHz (SNVA036)
- LM140K Series 3-Terminal Positive Regulators (SNVS994)

11.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

TECHNICAL TOOLS & SUPPORT & PRODUCT FOLDER **SAMPLE & BUY PARTS DOCUMENTS SOFTWARE** COMMUNITY LM340 Click here Click here Click here Click here Click here LM340A Click here Click here Click here Click here Click here LM7805 Click here Click here Click here Click here Click here LM7812 Click here Click here Click here Click here Click here LM7815 Click here Click here Click here Click here Click here

Table 1. Related Links

11.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on Alert me to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

11.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support TI's Design Support Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.5 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

11.6 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.7 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.





12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LM340AT-5.0	NRND	TO-220	NDE	3	45	Non-RoHS & Green	Call TI	Level-1-NA-UNLIM	0 to 70	LM340AT 5.0 P+	
LM340AT-5.0/NOPB	ACTIVE	TO-220	NDE	3	45	RoHS-Exempt & Green	SN	Level-1-NA-UNLIM	0 to 125	LM340AT 5.0 P+	Samples
LM340K-5.0	ACTIVE	TO-3	NDS	2	50	Non-RoHS & Non-Green	Call TI	Call TI	0 to 125	LM340K -5.0 7805P+	Samples
LM340K-5.0/NOPB	ACTIVE	TO-3	NDS	2	50	RoHS & Green	Call TI	Level-1-NA-UNLIM	0 to 125	LM340K -5.0 7805P+	Samples
LM340MP-5.0	NRND	SOT-223	DCY	4	1000	Non-RoHS & Green	Call TI	Level-1-260C-UNLIM	0 to 70	N00A	
LM340MP-5.0/NOPB	ACTIVE	SOT-223	DCY	4	1000	RoHS & Green	SN	Level-1-260C-UNLIM	0 to 125	N00A	Samples
LM340MPX-5.0/NOPB	ACTIVE	SOT-223	DCY	4	2000	RoHS & Green	SN	Level-1-260C-UNLIM	0 to 125	N00A	Samples
LM340S-12/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	45	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	0 to 125	LM340S -12 P+	Samples
LM340S-5.0	NRND	DDPAK/ TO-263	KTT	3	45	Non-RoHS & Green	Call TI	Level-3-235C-168 HR	0 to 70	LM340S -5.0 P+	
LM340S-5.0/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	45	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	0 to 125	LM340S -5.0 P+	Samples
LM340SX-12/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	500	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	0 to 125	LM340S -12 P+	Samples
LM340SX-5.0	NRND	DDPAK/ TO-263	KTT	3	500	Non-RoHS & Green	Call TI	Level-3-235C-168 HR	0 to 70	LM340S -5.0 P+	
LM340SX-5.0/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	500	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	0 to 125	LM340S -5.0 P+	Samples
LM340T-12	NRND	TO-220	NDE	3	45	Non-RoHS & Green	Call TI	Level-1-NA-UNLIM	0 to 70	LM340T12 7812 P+	
LM340T-12/NOPB	ACTIVE	TO-220	NDE	3	45	RoHS & Green	SN	Level-1-NA-UNLIM		LM340T12 7812 P+	Samples
LM340T-15	NRND	TO-220	NDE	3	45	Non-RoHS & Green	Call TI	Level-1-NA-UNLIM	0 to 70	LM340T15 7815 P+	
LM340T-15/NOPB	ACTIVE	TO-220	NDE	3	45	RoHS & Green	SN	Level-1-NA-UNLIM	0 to 125	LM340T15 7815 P+	Samples



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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LM340T-5.0	NRND	TO-220	NDE	3	45	Non-RoHS & Green	Call TI	Level-1-NA-UNLIM	0 to 70	LM340T5 7805 P+	
LM340T-5.0/LF01	ACTIVE	TO-220	NDG	3	45	RoHS-Exempt & Green	SN	Level-4-260C-72 HR	0 to 125	LM340T5 7805 P+	Samples
LM340T-5.0/NOPB	ACTIVE	TO-220	NDE	3	45	RoHS-Exempt & Green	SN	Level-1-NA-UNLIM	0 to 125	LM340T5 7805 P+	Samples
LM7805CT	NRND	TO-220	NDE	3	45	Non-RoHS & Green	Call TI	Level-1-NA-UNLIM	0 to 125	LM340T5 7805 P+	
LM7805CT/NOPB	ACTIVE	TO-220	NDE	3	45	RoHS-Exempt & Green	SN	Level-1-NA-UNLIM	0 to 125	LM340T5 7805 P+	Samples
LM7805MP/NOPB	ACTIVE	SOT-223	DCY	4	1000	RoHS & Green	SN	Level-1-260C-UNLIM	0 to 125	N00A	Samples
LM7805MPX/NOPB	ACTIVE	SOT-223	DCY	4	2000	RoHS & Green	SN	Level-1-260C-UNLIM	0 to 125	N00A	Samples
LM7805S/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	45	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	0 to 125	LM340S -5.0 P+	Samples
LM7805SX/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	500	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	0 to 125	LM340S -5.0 P+	Samples
LM7812CT/NOPB	ACTIVE	TO-220	NDE	3	45	RoHS & Green	SN	Level-1-NA-UNLIM	-40 to 125	LM340T12 7812 P+	Samples
LM7812S/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	45	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	0 to 125	LM340S -12 P+	Samples
LM7812SX/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	500	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	0 to 125	LM340S -12 P+	Samples
LM7815CT/NOPB	ACTIVE	TO-220	NDE	3	45	RoHS & Green	SN	Level-1-NA-UNLIM	0 to 125	LM340T15 7815 P+	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".



PACKAGE OPTION ADDENDUM

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Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM340MP-5.0	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM340MP-5.0/NOPB	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM340MPX-5.0/NOPB	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM340SX-12/NOPB	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM340SX-5.0	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM340SX-5.0/NOPB	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM7805MP/NOPB	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM7805MPX/NOPB	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM7805SX/NOPB	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM7812SX/NOPB	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2



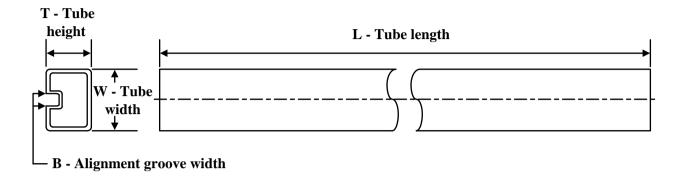


*All dimensions are nominal

7 til dilitionolorio aro mominai							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM340MP-5.0	SOT-223	DCY	4	1000	367.0	367.0	35.0
LM340MP-5.0/NOPB	SOT-223	DCY	4	1000	367.0	367.0	35.0
LM340MPX-5.0/NOPB	SOT-223	DCY	4	2000	367.0	367.0	35.0
LM340SX-12/NOPB	DDPAK/TO-263	KTT	3	500	367.0	367.0	45.0
LM340SX-5.0	DDPAK/TO-263	KTT	3	500	367.0	367.0	45.0
LM340SX-5.0/NOPB	DDPAK/TO-263	KTT	3	500	367.0	367.0	45.0
LM7805MP/NOPB	SOT-223	DCY	4	1000	367.0	367.0	35.0
LM7805MPX/NOPB	SOT-223	DCY	4	2000	367.0	367.0	35.0
LM7805SX/NOPB	DDPAK/TO-263	KTT	3	500	367.0	367.0	45.0
LM7812SX/NOPB	DDPAK/TO-263	KTT	3	500	367.0	367.0	45.0



TUBE

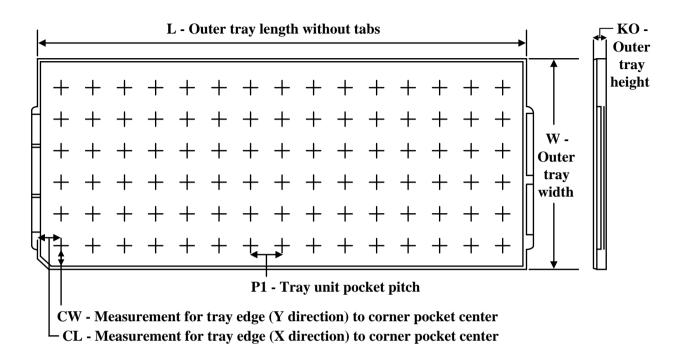


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
LM340AT-5.0	NDE	TO-220	3	45	502	33	6985	4.06
LM340AT-5.0	NDE	TO-220	3	45	502	33	6985	4.06
LM340AT-5.0/NOPB	NDE	TO-220	3	45	502	33	6985	4.06
LM340S-12/NOPB	KTT	TO-263	3	45	502	25	8204.2	9.19
LM340S-5.0	KTT	TO-263	3	45	502	25	8204.2	9.19
LM340S-5.0	KTT	TO-263	3	45	502	25	8204.2	9.19
LM340S-5.0/NOPB	KTT	TO-263	3	45	502	25	8204.2	9.19
LM340T-12	NDE	TO-220	3	45	502	33	6985	4.06
LM340T-12	NDE	TO-220	3	45	502	33	6985	4.06
LM340T-12/NOPB	NDE	TO-220	3	45	502	33	6985	4.06
LM340T-15	NDE	TO-220	3	45	502	33	6985	4.06
LM340T-15	NDE	TO-220	3	45	502	33	6985	4.06
LM340T-15/NOPB	NDE	TO-220	3	45	502	33	6985	4.06
LM340T-5.0	NDE	TO-220	3	45	502	33	6985	4.06
LM340T-5.0	NDE	TO-220	3	45	502	33	6985	4.06
LM340T-5.0/LF01	NDG	TO-220	3	45	502	25	8204.2	9.19
LM340T-5.0/NOPB	NDE	TO-220	3	45	502	33	6985	4.06
LM7805CT	NDE	TO-220	3	45	502	33	6985	4.06
LM7805CT	NDE	TO-220	3	45	502	33	6985	4.06
LM7805CT/NOPB	NDE	TO-220	3	45	502	33	6985	4.06
LM7805S/NOPB	KTT	TO-263	3	45	502	25	8204.2	9.19
LM7812CT/NOPB	NDE	TO-220	3	45	502	33	6985	4.06
LM7812S/NOPB	KTT	TO-263	3	45	502	25	8204.2	9.19
LM7815CT/NOPB	NDE	TO-220	3	45	502	33	6985	4.06



TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	Κ0 (μm)	P1 (mm)	CL (mm)	CW (mm)
LM340K-5.0	NDS	TO-CAN	2	50	9 X 6	NA	292.1	215.9	25654	3.87	22.3	25.4
LM340K-5.0/NOPB	NDS	TO-CAN	2	50	9 X 6	NA	292.1	215.9	25654	3.87	22.3	25.4







DCY (R-PDSO-G4)

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters (inches).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion.

D. Falls within JEDEC TO-261 Variation AA.

DCY (R-PDSO-G4)

PLASTIC SMALL OUTLINE



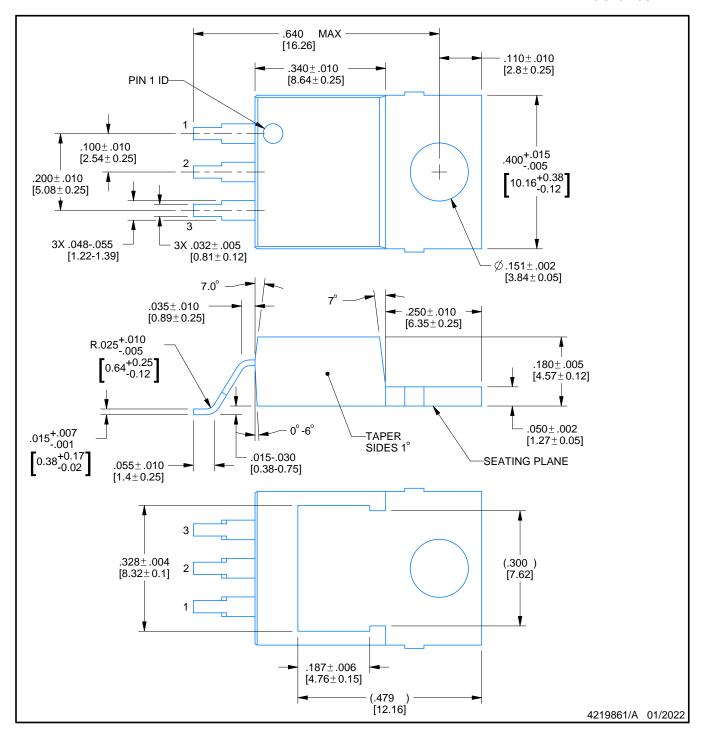
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil recommendations. Refer to IPC 7525 for stencil design considerations.





TRANSISTOR OUTLINE

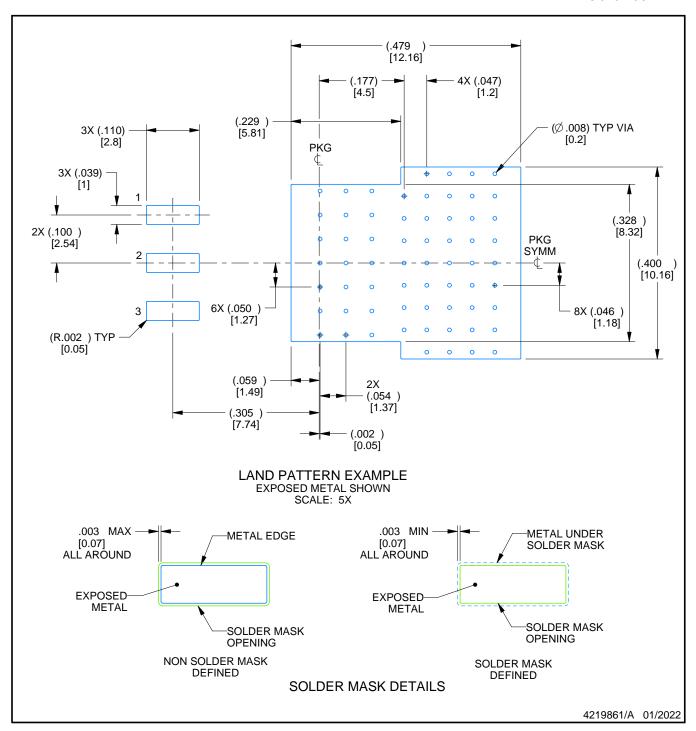


NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.



TRANSISTOR OUTLINE

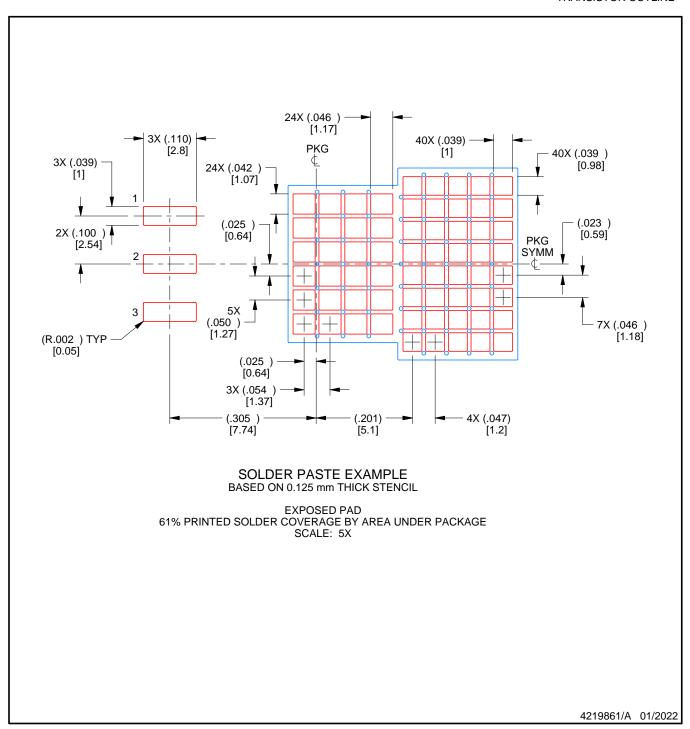


NOTES: (continued)

- 3. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002(www.ti.com/lit/slm002) and SLMA004 (www.ti.com/lit/slma004).
- 4. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.



TRANSISTOR OUTLINE



NOTES: (continued)

- 5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 6. Board assembly site may have different recommendations for stencil design.



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